

# GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

#### Typical Applications

The HMC187AMS8(E) is ideal for:

- Wireless Local Loop
- LMDS, VSAT, and Point-to-Point Radios
- UNII & HiperLAN
- Test Equipment

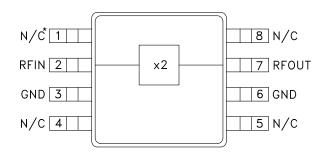
#### **Features**

Conversion Loss: 15 dB

Fo, 3Fo, 4Fo Isolation: 40 dB

Input Drive Level: 10 to 20 dBm

#### **Functional Diagram**



#### **General Description**

The HMC187AMS8(E) is a miniature frequency doubler MMIC in plastic 8-lead MSOP package. The suppression of undesired fundamental and higher order harmonics is 40 dB typical with respect to input signal levels. The doubler uses the same diode/balun technology used in Hittite MMIC mixers. The doubler is ideal for high volume applications where frequency doubling of a lower frequency is more economical than directly generating a higher frequency. The passive Schottky diode doubler technology contributes no measurable additive phase noise onto the multiplied signal.

### Electrical Specifications, $T_{\Delta} = +25^{\circ}$ C, As a Function of Drive Level

	Input = +10 dBm		Input = +15 dBm			Input = +20 dBm				
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, Input		1.25 - 1.75			1.0 - 1.75			0.85 - 2.0		GHz
Frequency Range, Output		2.5 - 3.5			2.0 - 3.5			1.7 - 4.0		GHz
Conversion Loss		18	22		14	17		15	18	dB
FO Isolation (with respect to input level)				35	45					dB
3FO Isolation (with respect to input level)				42	46					dB
4FO Isolation (with respect to input level)				30	40					dB

<sup>\*</sup> N/C denotes no internal connection, however, it is recommended to connect these pins to ground.

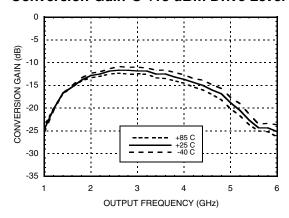
# MICROWAVE CORPORATION

# **HMC187AMS8 / 187AMS8E**

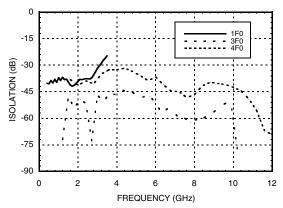
# GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT



#### Conversion Gain @ +15 dBm Drive Level

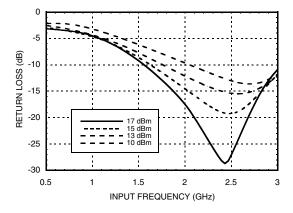


#### Isolation @ +15 dBm Drive Level\*

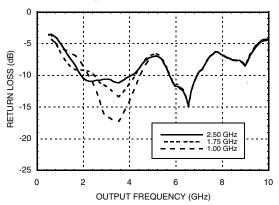


\*With respect to input level

#### Input Return Loss vs. Drive Level



# Output Return Loss for Several Input Frequencies

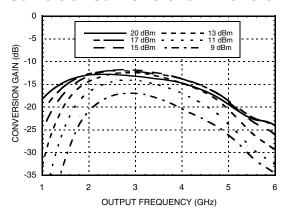




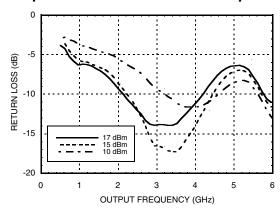
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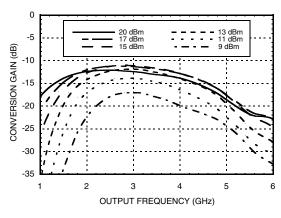
#### Conversion Gain @ 25°C vs. Drive Level



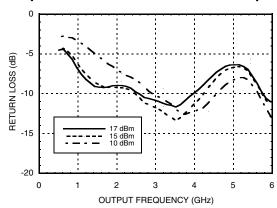
#### **Output Return Loss with 1 GHz Input**



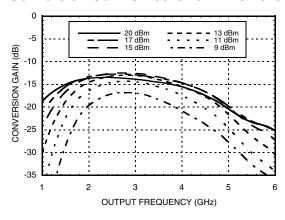
#### Conversion Gain @ -40°C vs. Drive Level



#### **Output Return Loss with 1.75 GHz Input**

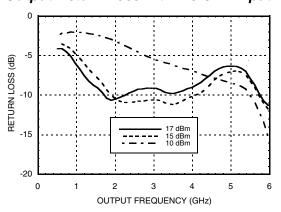


#### Conversion Gain @ +85°C vs. Drive Level



Application Sup

#### **Output Return Loss with 2.5 GHz Input**







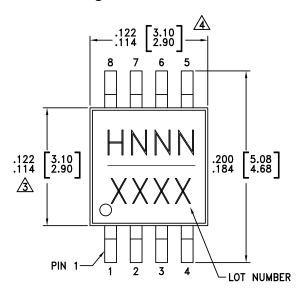
# GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

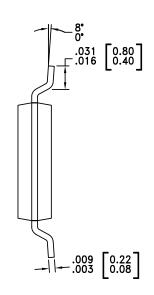
#### **Absolute Maximum Ratings**

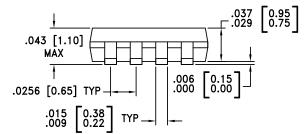
Input Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C



#### **Outline Drawing**







#### NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

#### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]	
HMC187AMS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H187A XXXX	
HMC187AMS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H187A XXXX	

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX



# GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 0.85 - 2.0 GHz INPUT

# ROHS V

#### Pin Description

Pin Number	Function	Description	Interface Schematic
1, 4, 5, 8	N/C	These pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
3, 6	GND	All ground leads must be soldered to PCB RF/DC ground.	GND =
2	RFIN	Pin is DC coupled and matched to 50 Ohms.	RFIN O
7	RFOUT	Pin is DC coupled and matched to 50 Ohms.	RFOUT

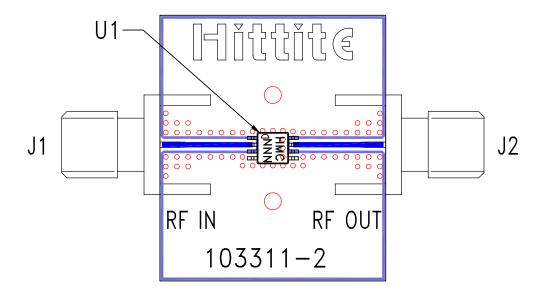






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#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 103313 [1]

Item	Description	
J1, J2	PCB Mount SMA Connector	
U1	HMC187AMS8(E) Doubler	
PCB [2]	103311 Eval Board	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package N/C and ground leads should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request.

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